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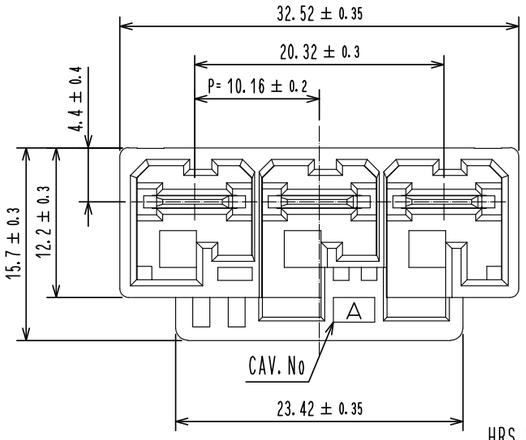
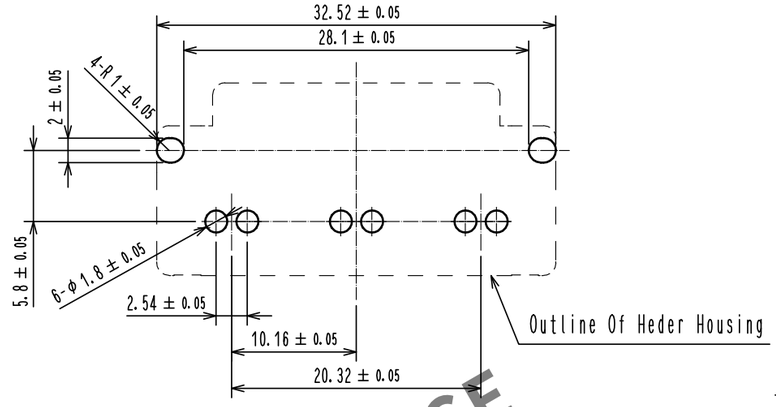
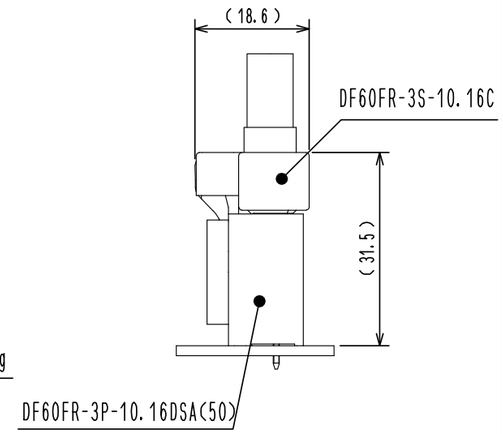
In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

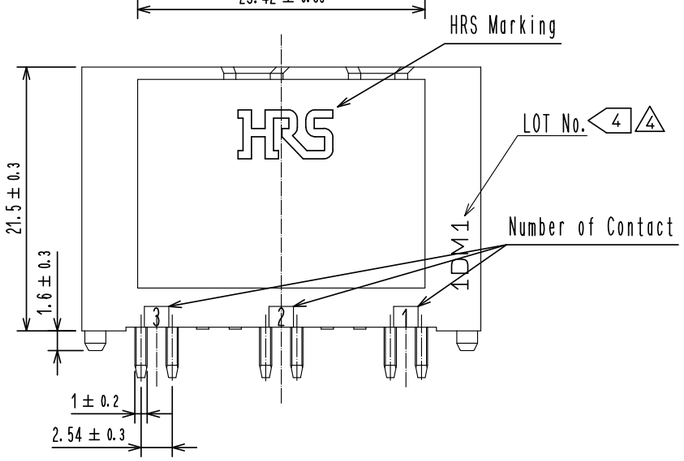


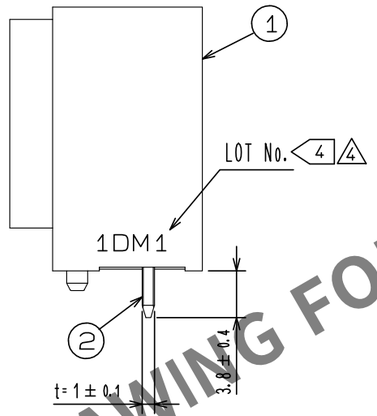
Recommended PCB Layout
(Board thickens : t=1.6±0.1mm)

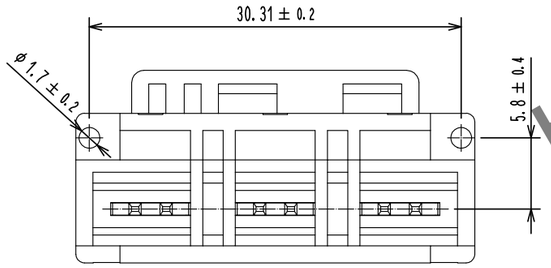


Aprication Diagram(1:1)

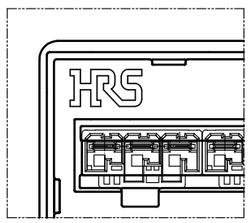


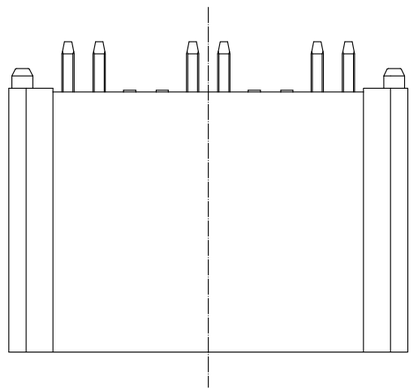




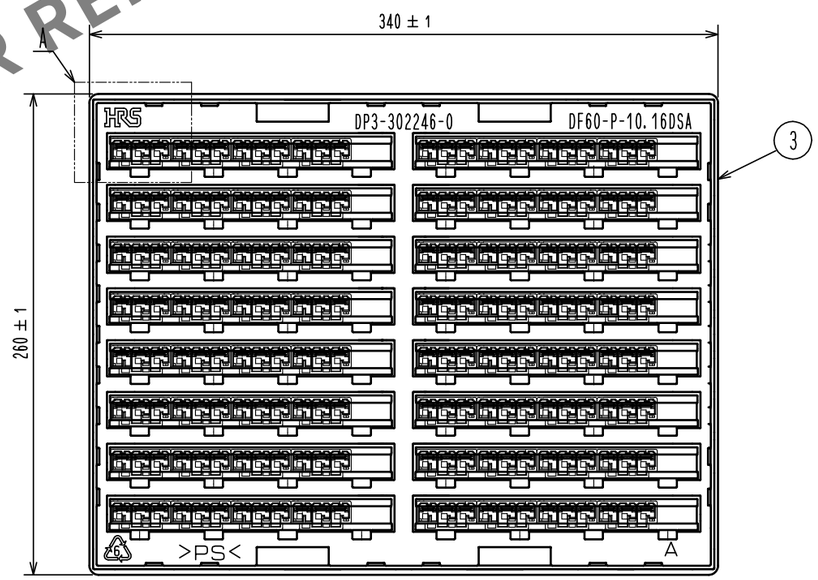


A(FREE)





Packaging Diagram (FRRE)



Notes 1. Per tray : 64 Pieces.
2. Refer to the technical specification (ETAP-H0816-00) for the packing type.
3. UL(File No.E52653)
C-UL(File No.E52653)
TUV (Certificate No. R50400864) authorization article.

4 4 Lot No. is displayed in one of the two locations.

NO.	MATERIAL	FINISH , REMARKS
1	PBT	Red. 94-V0
2	Copper Alloy	Contact Area : Au Plating 0.2μm min LEAD Area : Tin Plating 1μm min Under Plating : Ni Plating 1μm min
3	PS	White

UNITS	SCALE		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm	2 : 1	4	3	DIS-H-00012301	TS.MIYAKI	SZ.ONO	20220217

HIROSE ELECTRIC CO., LTD.

APPROVED	HS.OKAWA	20171011
CHECED	ST.WADA	20171011
DESIGNED	TT.OHSAKO	20171011
DRAWN	TT.OHSAKO	20171011

DRAWING NO.	EDC-379290-50-00
PART NO.	DF60FR-3P-10.16DSA(50)
CODE NO.	CL0680-4004-0-50

4 1/1

HRS DRAWING FOR REFERENCE